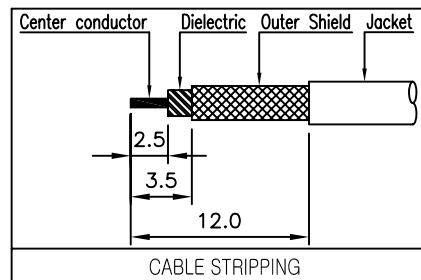
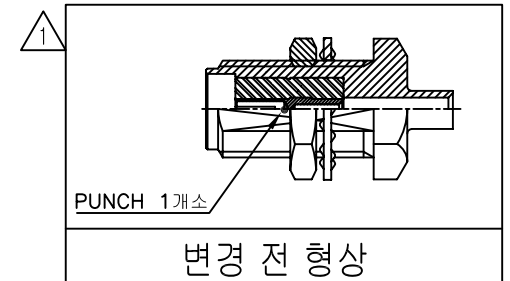
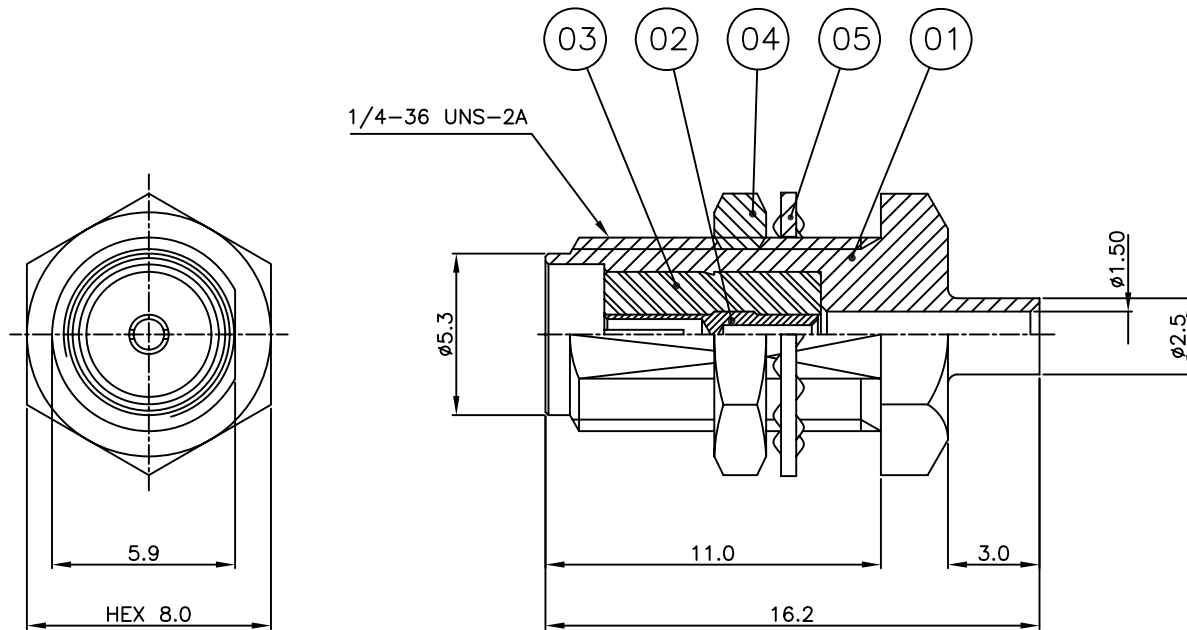


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM	J.H.YOUN	2009. 11. 11
1	[설번No.201307-0003] 조립성 및 신뢰성 향상. BODY 내부 넉시틱 및 면취 추가.	M.H.SONG	I.C.KIM	2013. 07. 11.
2	절연체 공용화로 인한 코드 변경	S.Y.EUN	I.C.KIM	2021. 10. 15.



5	WASHER	1	BsS	Gold Plate	DWA00005-5/1 (Q2008)
4	NUT	1	MBsBD	Gold Plate	DNT00025-5/1 (N2002)
3	INSULATOR	1	TEFLON		DIN02657-N/2 DIN00153-N/1 (H2298)
2	CONTACT	1	BeCu	Gold Plate	DCT02141-5/1
1	BODY	1	MBsBD	Gold Plate	DBD00182-5/1 (D2420)
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2021. 10. 15.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		TITLE SMA50 CABLE JB (F/N) 47TP
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	UNIT	DWG NO. CN00878-7/2 REVISION 2 SHEET 1 of 1
		4/1	mm	

A4